# LCD / LCM SPECIFICATION



WINSTAR Display Co.,Ltd. 華凌光電股份有限公司





# Winstar Display Co., LTD 華凌光電股份有限公司



### **SPECIFICATION**

<b>CUSTOMER</b> :	~ ( )
MODULE NO.:	WG19264D-TMI-V#N

APPROVED BY:		
FOR CUSTOMER USE ONLY)	PCB VERSION:	DATA:

SALES BY	APPROVED BY	CHECKED BY	PREPARED BY
N/S	<b>&gt;</b> '		

VERSION	DATE	REVISED PAGE NO.		SUMMARY
D	2016/01/27			Precautions in CD Modules
			& Static	c electricity test



### Winstar Display Co., LTD MODLE NO: 華凌光電股份有限公司

REC	ORDS OF REV	ISION	Γ	OOC. FIRST ISSUE
VERSION	DATE	REVISED PAGE NO.	·	SUMMARY
0	2008/08/06		Fir	st issue
A	2009/06/16		Mc	dify Timing
			Cha	aracteristics
В	2014/06/25		Rei	move IC information
			Co	rrect VDD-V0 &
			Ab	solute Maximum
		40	Rat	tings.
С	2015/06/15		Mc	dify Backlight
			Inf	ormation.
D	2016/01/27		$\overline{Mc}$	odify Precautions in use
			of l	LCD Modules
	(C)		&	Static electricity test



### **Contents**

- 1.Module Classification Information
- 2. Precautions in use of LCD Modules
- 3.General Specification
- 4. Absolute Maximum Ratings
- 5. Electrical Characteristics
- 6. Optical Characteristics
- 7.Interface Pin Function
- 8. Contour Drawing & Block Diagram
- 9.Reliability
- 10.Backlight Information
- 11.Inspection specification
- 12. Material List of Components for RoHs
- 13.Recommendable Storage



### 1. Module Classification Information

W	<u>G</u>	<u>19264</u>	D	_	<u>T</u>	<u>M</u>	I	_	<u>V#N</u>
1	2	3	4		(5)	6	7		8

① Brand: WINSTAR DISPLAY CORPORATION

② Display Type: H→Character Type, G→Graphic Type, X→TAB Type, O→COG Type

③ Display Font: 192 \* 64 dot

Model serials no.

 $B \rightarrow EL$ , Blue green  $A \rightarrow LED$ , Amber  $L \rightarrow LED$ , Full color  $D \rightarrow EL$ , Green  $R \rightarrow LED$ , Red  $J \rightarrow DIP LED$ , Blue  $W \rightarrow EL$ , White  $O \rightarrow LED$ , Orange  $K \rightarrow DIP LED$ , White

M→EL, Yellow Green G→LED, Green E→DIP LED, Yellow Green

 $F\rightarrow$ CCFL, White  $P\rightarrow$ LED, Blue  $H\rightarrow$ DIP LED, Amber  $Y\rightarrow$ LED, Yellow Green  $X\rightarrow$ LED, Dual color  $I\rightarrow$ DIP LED, Red

G→LED, Green C→LED, Full color

© LCD Mode : B→TN Positive, Gray V→FSTN Negative, Blue

N→TN Negative, T→FSTN Negative, Black

L→VA Negative D→FSTN Negative (Double film)

 $H \rightarrow HTN$  Positive, Gray  $F \rightarrow FSTN$  Positive  $I \rightarrow HTN$  Negative, Black  $K \rightarrow FSC$  Negative  $U \rightarrow HTN$  Negative, Blue  $S \rightarrow FSC$  Positive

M→STN Negative, Blue E→ISTN Negative, Black
G→STN Positive, Gray C→CSTN Negative, Black
Y→STN Positive, Yellow Green A→ASTN Negative, Black

② LCD Polarize A→Reflective, N.T, 6:00 H→Transflective, W.T,6:00

Type/ Temperature D→Reflective, N.T, 12:00 K→Transflective, W.T,12:00

range/ View G→Reflective, W. T, 6:00 C→Transmissive, N.T,6:00

direction J→Reflective, W. T, 12:00 F→Transmissive, N.T,12:00

B→Transflective, N.T,6:00 I→Transmissive, W. T, 6:00

E→Transflective, N.T.12:00 L→Transmissive, W.T,12:00

Special Code
V : Build in negative voltage

#:Fit in with the ROHS Directions and regulations

N:IC NT7107, NT7108



### 2. Precautions in use of LCD Modules

- (1) Avoid applying excessive shocks to the module or making any alterations or modifications to it.
- (2)Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD module.
- (3)Don't disassemble the LCM.
- (4)Don't operate it above the absolute maximum rating.
- (5)Don't drop, bend or twist LCM.
- (6) Soldering: only to the I/O terminals.
- (7)Storage: please storage in anti-static electricity container and clean environment.
- (8) Winstar have the right to change the passive components, including R3,R6 & backlight adjust resistors. (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.)
- (9) Winstar have the right to change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise of not affecting the electrical characteristics and external dimensions, Winstar have the right to modify the version.)
- (10) To ensure the stability of the display screen, please apply screen saver after showing 30 mins of fixed display content.





# **3.General Specification**

Item	Dimension	Unit
Number of dots	192 x 64	_
Module dimension	120.0 x 62.0 x 12.9 (MAX)	mm
View area	102.0 x 39.0	mm
Active area	96.0 x 32.0	mm
Dot size	0.46 x 0.46	mm
Dot pitch	0.50 x 0.50	mm
LCD type	STN Negative, Blue Transmissive  (In LCD production, It will occur slightly color of can only guarantee the same color in the same based on the same based o	
Duty	1/64	
View direction	6 o'clock	
Backlight Type	LED, White	
IC	NT7107, NT7108	



# **4.Absolute Maximum Ratings**

Item	Symbol	Min	Тур	Max	Unit
Operating Temperature	$T_{\mathrm{OP}}$	-20	_	+70	$^{\circ}\!\mathbb{C}$
Storage Temperature	$T_{ST}$	-30	_	+80	$^{\circ}\!\mathbb{C}$
Supply Voltage For Logic	$V_{DD}$ - $V_{SS}$	-0.3	_	7.0	V
Driver Supply Voltage	$V_{ m LCD}$	V <sub>EE</sub> -0.3	_	V <sub>DD</sub> +0.3	V



# **5.Electrical Characteristics**

ITEM	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT
Supply Voltage For Logic	$V_{DD}$ - $V_{SS}$	_	4.5	5.0	5.5	V
Supply Voltage For		Ta=-20°C	_	_		V
LCD	$V_{DD}$ - $V_{O}$	Ta=25°C	7.8	8.55	9.3	V'
		Ta=70°C	_	_	_	V
Input High Volt.	$V_{\mathrm{IH}}$	_	$0.7~\mathrm{V_{DD}}$	_	$V_{ m DD}$	V
Input Low Volt.	$V_{IL}$	_	0		0.8	V
Output High Volt.	$V_{\mathrm{OH}}$	_	2.4		_	V
Output Low Volt.	$V_{\mathrm{OL}}$			<del>-</del>	0.4	V
Supply Current	$I_{DD}$	V <sub>DD</sub> =5.0V		8.0		mA

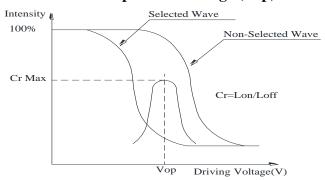


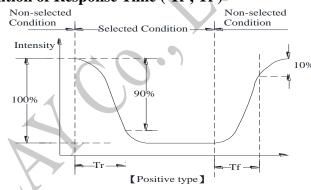
## **6.Optical Characteristics**

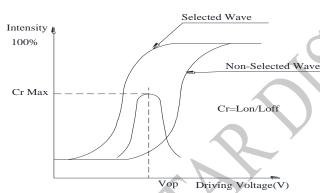
Item	Symbol	Condition	Min	Тур	Max	Unit
View Angle	θ	CR≧2	0	_	20	$\phi = 180^{\circ}$
	θ	CR≧2	0	_	40	$\phi = 0^{\circ}$
	$\theta$	CR≧2	0	_	30	$\phi = 90^{\circ}$
	θ	CR≧2	0	_	30	$\phi = 270^{\circ}$
Contrast Ratio	CR	_	_	3	_	_
Dagmanaa Tima	T rise	_	_	200	300	ms
Response Time	T fall	_	_	250	350	ms

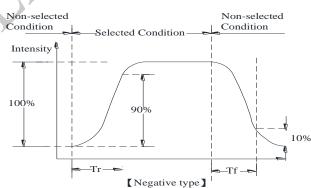
#### **Definition of Operation Voltage (Vop)**

### **Definition of Response Time (Tr, Tf)**Non-selected









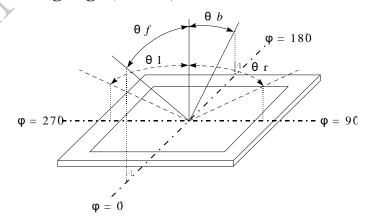
#### **Conditions:**

Operating Voltage: Vop

Viewing Angle( $\theta$ ,  $\varphi$ ):  $0^{\circ}$ ,  $0^{\circ}$ 

Frame Frequency: 64 HZ Driving Waveform: 1/N duty, 1/a bias

#### Definition of viewing angle $(CR \ge 2)$



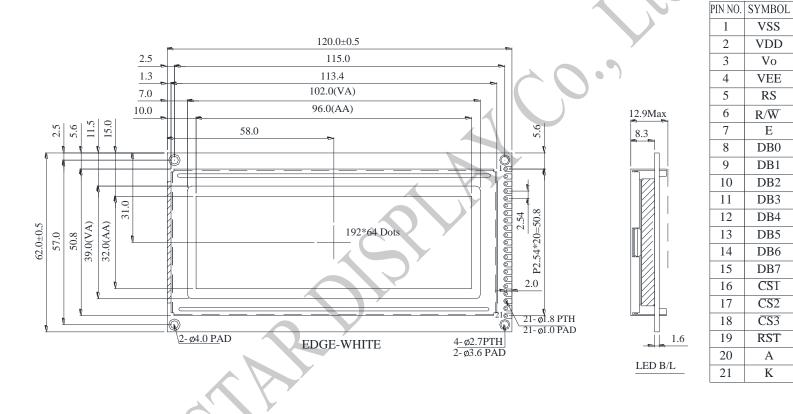


# 7.Interface Pin Function

Pin No.	Symbol	Level	Description
1	V <sub>SS</sub>	0V	Ground
2	$V_{DD}$	5.0V	Supply voltage for logic
3	Vo	(Variable)	Operating voltage for LCD
4	Vee	_	Negative Voltage Output
5	RS	H/L	H: DATA, L: Instruction code
6	R/W	H/L	H: Read (MPU←Module) , L: Write (MPU→Module)
7	Е	Н	Enable signal
8	DB0	H/L	Data bus line
9	DB1	H/L	Data bus line
10	DB2	H/L	Data bus line
11	DB3	H/L	Data bus line
12	DB4	H/L	Data bus line
13	DB5	H/L	Data bus line
14	DB6	H/L	Data bus line
15	DB7	H/L	Data bus line
16	/CS1	Н	Select Column 1~ Column 64
17	/CS2	Н	Select Column 65~ Column 128
18	/CS3	Н	Select Column 65~ Column 128
19	/RST	L	Reset signal
20	A	_	Power supply for LED +
21	K	_	Power supply for LED -



## **8.Contour Drawing & Block Diagram**



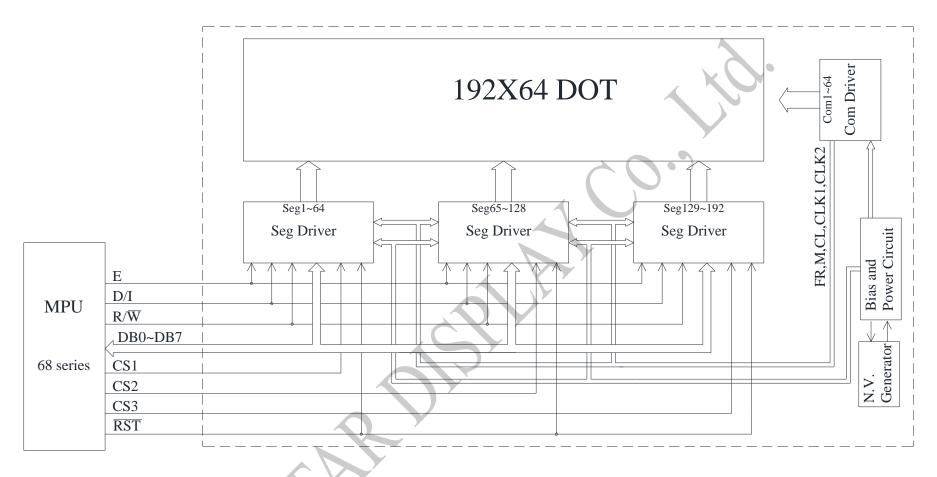
0.46 DOT SIZE

0.50

SCALE 10/1

The non-specified tolerance of dimension is  $\pm 0.3$ mm.







## 9.Reliability

Content of Reliability Test (Wide temperature, -20°C~70°C)

	<b>Environmental Test</b>		
Test Item	Content of Test	<b>Test Condition</b>	Not e
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80°C 200hrs	2
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-30°C 200hrs	1,2
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70°C 200hrs	
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20℃ 200hrs	1
High Temperature/ Humidity storage	The module should be allowed to stand at 60 °C,90% RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature.	60°C,90%RH 96hrs	1,2
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation  -20°C 25°C 70°C  30min 5min 30min 1 cycle	-20°C/70°C 10 cycles	_
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude: 1.5mm Vibration Frequency: 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=±600V(contact), ±800v(air), RS=330Ω CS=150pF 10 times	_

Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal

Temperature and humidity after remove from the test chamber.

Note3: The packing have to including into the vibration testing.



## **10.Backlight Information**

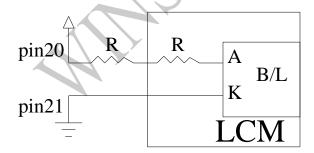
#### **Specification**

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT	TEST CONDITION
Supply Current	ILED	_	80	100	mA	V=3.5V
Supply Voltage	v	3.4	3.5	3.6	V	- × O
Reverse Voltage	VR	_	_	5	V	-
Luminance (Without LCD)	IV	440	550	_	CD/M <sup>2</sup>	ILED=80mA
LED Life Time (For Reference only)	_	_	50K	- \	Hr.	ILED=80mA 25°C,50-60%RH, (Note 1)
Color	White			VY		

Note: The LED of B/L is drive by current only, drive voltage is for reference only. drive voltage can make driving current under safety area (current between minimum and maximum).

Note 1:50K hours is only an estimate for reference.

Drive from pin20,pin21





# 11.Inspection specification

NO	Item	Criterion				AQL	
		Missing vertical	, horizonta	al segment, segmen	nt contrast defect.		
		Missing character, dot or icon.					
		Display malfund	ction.				
0.1	Electrical	No function or r	no display.			0.65	
01	Testing	Current consum	ption exce	eds product specif	ications.	0.65	
		LCD viewing ar	ngle defect	<u>.</u>	V C		
		Mixed product t	ypes.		4		
		Contrast defect.					
	Black or	2.1 White and b	lack snots	on display $\leq 0.25$	mm no more than		
02	white spots on	three white or b	-		inni, no more than	2.5	
02	LCD (display		-	-	or lines within 3mm	2.3	
	only)	2.2 Densery spar		soro man two spots	or mes within shiff		
		2.1 D 14	. A - C 11				
		3.1 Round type $\Phi$					
		$\Phi = (x + y) / 2$		SIZE	Acceptable Q TY		
		→ X <b>←</b>	l V	$\Phi \leq 0.10$	Accept no dense	2.5	
			v	$0.10 < \Phi \le 0.20$	2		
	LCD black		¥↑₽	$0.20 < \Phi \le 0.25$	1		
	spots, white		<b>\</b>	$0.25 < \Phi$	0		
03	spots,						
	contamination	3.2 Line type : (					
	(non-display)	<u>.</u>	Length	Width	Acceptable Q TY		
		~ ↓ <u>w</u>		W≦0.02	Accept no dense		
	16	→ i L +←	L≦3.0	$0.02 < W \le 0.03$		2.5	
	2		L≦2.5	$0.03 < W \le 0.05$	_		
				0.05 < W	As round type		
		If bubbles are vi	sible	Size Φ	Acceptable Q TY		
		judge using blace	ŕ	Φ≦0.20	Accept no dense		
04	Polarizer	specifications, n	_	$0.20 < \Phi \le 0.50$	3	2.5	
-	bubbles	to find, must che	=	$0.50 < \Phi \le 1.00$	2		
		specify direction		1.00 < Φ	0		
		Total Q TY 3					



NO	Item	Criterion			AQL
05	Scratches	Follow NO.3 LCD blace	k spots, white spots, co	ntamination	
		Symbols Define:			
		x: Chip length y:	Chip width z: Ch	ip thickness	
		k: Seal width t:	Glass thickness a: LC	CD side length	
		L: Electrode pad length	:		
		6.1 General glass chip:		_	
		6.1.1 Chip on panel sur	face and crack between	panels:	
			N. C.		
		z: Chip thickness	y: Chip width	x: Chip length	
		Z≦1/2t	Not over viewing	x≤1/8a	
06	Chipped		area		2.5
	glass	$1/2t < z \le 2t$	Not exceed 1/3k	x≤1/8a	
		⊙ If there are 2 or more 6.1.2 Corner crack:	chips, x is total length	of each chip.	
		z: Chip thickness	y: Chip width	x: Chip length	
	N	$Z \leq 1/2t$	Not over viewing	$x \le 1/8a$	
			area		
		$1/2t < z \leq 2t$	Not exceed 1/3k	x≤1/8a	
	⊙ If there are 2 or more chips, x is the total length of each chip.				



NO	Item	Criterion				A	AQL	
		Symbols:						
			Chip width	z: Chip thic	kness			
			Blass thickness	a: LCD side				
		L: Electrode pad length			C			
		•	5.2 Protrusion over terminal :					
		6.2.1 Chip on electrode p	ad:					
			آ مد			. 2		
			AL SI			KO		
		War V		L <sup>Z</sup>				
		1 STA						
		V.	AX.		~ O·J			
		y: Chip width	x: Chip length	z: C	hip thickness			
		y≦0.5mm	x ≤ 1/8a	0 <	$z \leq t$			
		6.2.2 Non-conductive por	rtion:		/	_		
			,		*	Ť		
06	Glass							
06	crack	Dan W	MAN.				2.5	
		* 7070	12	3	M 2			
		y	T 2	Y W	S. #   "			
		X	·		Х			
			7			ı		
		y: Chip width	x: Chip leng	gth z:	Chip thickness			
		y≦ L	$x \le 1/8a$	0	$< z \le t$			
		⊙If the chipped area tou	ches the ITO te	rminal, over	2/3 of the ITO m	ust		
	,	remain and be inspected a	according to ele	ctrode termi	nal specifications	3.		
		$\odot$ If the product will be h	eat sealed by th	e customer,	the alignment ma	ırk not		
		be damaged.						
		6.2.3 Substrate protubera	nce and interna	l crack.				
	1	X	y: widtl	1	x: length			
		The state of the s	$y \le 1/3I$		$x \leq a$			
		V	<u> </u>					
			33					



NO	Item	Criterion	AQL
07	Cracked glass	The LCD with extensive crack is not acceptable.	2.5
		8.1 Illumination source flickers when lit.	0.65
00	Backlight	8.2 Spots or scratched that appear when lit must be judged.	2.5
08	elements	Using LCD spot, lines and contamination standards.	
		8.3 Backlight doesn't light or color wrong.	0.65
		9.1 Bezel may not have rust, be deformed or have fingerprints,	2.5
09	Bezel	stains or other contamination.	
		9.2 Bezel must comply with job specifications.	0.65
		10.1 COB seal may not have pinholes larger than 0.2mm or	2.5
		contamination.	
		10.2 COB seal surface may not have pinholes through to the IC.	2.5
		10.3 The height of the COB should not exceed the height	0.65
		indicated in the assembly diagram.	
		10.4 There may not be more than 2mm of sealant outside the	2.5
		seal area on the PCB. And there should be no more than three	
		places.	
		10.5 No oxidation or contamination PCB terminals.	2.5
10	PCB · COB	10.6 Parts on PCB must be the same as on the production	0.65
	102 002	characteristic chart. There should be no wrong parts, missing	
		parts or excess parts.	
		10.7 The jumper on the PCB should conform to the product	0.65
		characteristic chart.	
		10.8 If solder gets on bezel tab pads, LED pad, zebra pad or	2.5
		screw hold pad, make sure it is smoothed down.	
		10.9 The Scraping testing standard for Copper Coating of PCB	2.5
	1	V	
	A	Y Y 2 2	
		X * Y <= 2mm <sup>2</sup>	2.5
		11.1 No un-melted solder paste may be present on the PCB.	2.5
11	Caldarina	11.2 No cold solder joints, missing solder connections,	2.5
11	Soldering	oxidation or icicle.	2.5
		11.3 No residue or solder balls on PCB.	2.5
		11.4 No short circuits in components on PCB.	0.65



NO	Item	Criterion	AQL
		12.1 No oxidation, contamination, curves or, bends on interface	2.5
		Pin (OLB) of TCP.	
		12.2 No cracks on interface pin (OLB) of TCP.	0.65
		12.3 No contamination, solder residue or solder balls on product.	2.5
		12.4 The IC on the TCP may not be damaged, circuits.	2.5
		12.5 The uppermost edge of the protective strip on the interface	2.5
		pin must be present or look as if it cause the interface pin to sever.	
	Cananal	12.6 The residual rosin or tin oil of soldering (component or chip	2.5
12	General	component) is not burned into brown or black color.	
	appearance	12.7 Sealant on top of the ITO circuit has not hardened.	2.5
		12.8 Pin type must match type in specification sheet.	0.65
		12.9 LCD pin loose or missing pins.	0.65
		12.10 Product packaging must the same as specified on packaging	0.65
		specification sheet.	
		12.11 Product dimension and structure must conform to product	0.65
		specification sheet.	
		12.12 Visual defect outside of VA is not considered to be rejection.	0.65



## 12.Material List of Components for

## **RoHs**

1. WINSTAR Display Co., Ltd hereby declares that all of or part of products (with the mark "#"in code), including, but not limited to, the LCM, accessories or packages, manufactured and/or delivered to your company (including your subsidiaries and affiliated company) directly or indirectly by our company (including our subsidiaries or affiliated companies) do not intentionally contain any of the substances listed in all applicable EU directives and regulations, including the following substances.

Exhibit A: The Harmful Material List

Material	(Cd)	(Pb)	(Hg)	(Cr6+)	PBBs	PBDEs
Limited Value	100 ppm	1000 ppm	1000 ppm	1000 ppm	1000 ppm	1000 ppm
Above limited value is set up according to RoHS.						

- 2.Process for RoHS requirement : (only for RoHS inspection)
  - (1) Use the Sn/Ag/Cu soldering surface; the surface of Pb-free solder is rougher than we used before.
  - (2) Heat-resistance temp. :

Reflow:  $250^{\circ}$ C, 30 seconds Max.

Connector soldering wave or hand soldering : 320°C, 10 seconds max.

(3) Temp. curve of reflow, max. Temp. :  $235\pm5$ °C;

Recommended customer's soldering temp. of connector: 280°C, 3 seconds.



## 13. Recommendable Storage

- 1. Place the panel or module in the temperature 25°C±5°C and the humidity below 65% RH
- 2. Do not place the module near organics solvents or corrosive gases.
- 3. Do not crush, shake, or jolt the module.





odule Number :		Page: 1	
1 · Panel Specification :			
1. Panel Type:	Pass	□ NG ,	
2. View Direction:	Pass	☐ NG ,	
3. Numbers of Dots:	Pass	□ NG ,	
4. View Area:	Pass	□ NG ,	
5. Active Area:	Pass	□ NG ,	
6. Operating Temperature:	Pass	□ NG ,	
7. Storage Temperature:	Pass	□ NG ,	Y
8. Others:			
2 · Mechanical Specification :		<b>Y</b>	
1. PCB Size:	Pass	□ NG ,	
2. Frame Size:	Pass	□ NG ,	
3. Materal of Frame:	Pass	□ NG ,	
4. Connector Position:	Pass	□ NG ,	
5. Fix Hole Position:	Pass	□ NG ,	
6. Backlight Position:	☐ Pass	□ NG ,	
7. Thickness of PCB:	☐ Pass	□ NG ,	
8. Height of Frame to PCB:	☐ Pass	□ NG ,	
9. Height of Module:	Pass	□ NG ,	
10. Others:	☐ Pass	□ NG ,	
3 · <u>Relative Hole Size</u> :			
1. Pitch of Connector:	☐ Pass	☐ NG ,	
2. Hole size of Connector:	Pass	☐ NG ,	
3. Mounting Hole size:	Pass	☐ NG ,	
4. Mounting Hole Type:	Pass	☐ NG ,	
5. Others:	Pass	☐ NG ,	
4 · Backlight Specification:			
1. B/L Type:	Pass	□ NG ,	
2. B/L Color:	Pass	□ NG ,	
3. B/L Driving Voltage (Refere	ence for LED T		
4. B/L Driving Current:	☐ Pass	□ NG ,	
5. Brightness of B/L:	☐ Pass	□ NG ,	
6. B/L Solder Method:	Pass	□ NG ,	
7. Others:	Pass	☐ NG ,	



	winstar

Module Number :		Page: 2
5 · Electronic Characteristics of	Module:	
1. Input Voltage:	Pass	□ NG ,
2. Supply Current:	Pass	□ NG ,
3. Driving Voltage for LCD:	Pass	□ NG ,
4. Contrast for LCD:	Pass	□ NG ,
5. B/L Driving Method:	Pass	□ NG ,
6. Negative Voltage Output:	☐ Pass	□ NG ,
7. Interface Function:	☐ Pass	□ NG ,
8. LCD Uniformity:	Pass	□ NG ,
9. ESD test:	Pass	□ NG,
10. Others:	Pass	□ NG ,
6 · <u>Summary</u> :		
Sales signature: Customer Signature:		